

## CONTACT INFORMATION

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## INTERESTED POSITION

MMTC Vice Chair - Letters and Member Communications

## SHORTBIO AND HOMEPAGE

### Short Bio

Dan Zeng received her Ph.D. degree in circuits and systems, and her B.S. degree in electronic science and technology, both from University of Science and Technology of China, Hefei. She is a full professor and the Dean of the Department of Communication Engineering and the Computer Vision and Pattern Recognition Lab at Shanghai University. Her main research interests include computer vision, multimedia analysis, and machine learning. She is serving as the Associate Editor of the IEEE Transactions on Multimedia, the Associate Editor of the IEEE Transactions on Circuits and Systems for Video Technology, the TC Member of IEEE MSA and TC member of IEEE MMSP.

She has published over 70 papers in top journals (e.g., TPAMI, TIP, TGRS, TMM, TCSVT, and TNNLS) and prestigious conferences (e.g., CVPR, ICCV, ECCV, IJCAI, AAAI, and ACM MM). She received several awards, including MMTC Best Journal Paper Award 2023, S&T Progress Award of the China Society of Image and Graphics 2022, China Industry-University-Research Collaboration Innovation Award 2023, and outstanding service award for IEEE ICME 2019.

### Homepage

<https://scie.shu.edu.cn/Prof/zengdan.htm>

## PAST INVOLVEMENT AND CONTRIBUTIONS

### Journal Editorships

1. *Associate Editor*, IEEE Transaction on Multimedia, 2021 - current
2. *Associate Editor*, IEEE Transactions on Circuits and Systems for Video Technology, 2022 - current
3. *Guest Editor*, Special Issue on "Learning From Noisy Multimedia Data", IEEE Transaction on Multimedia, 2022
4. *Guest Editor*, Special Issue on "Trustworthy Multimedia Computing and Applications in Urban Scenes", ACM Transactions on Multimedia Computing, Communications and Applications, 2023

### Community Service

1. *TC member*, IEEE MSA, 2021 - current
2. *TC member*, IEEE MMSP, 2022 - current
3. *Associate Chair*, CCF CTO Club (Shanghai), 2021 - 2024

## SELECTED AWARDS AND HONORS

1. *Best Journal Paper Award*, IEEE MMTC 2023
2. *First Prize*, China Industry-University-Research Collaboration Innovation Award 2023
3. *First Prize*, S&T Progress Award of the China Society of Image and Graphics 2023
4. *Outstanding Service Award*, IEEE ICME 2019